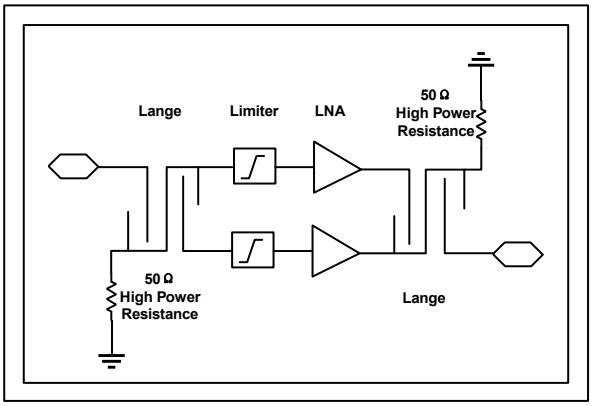
1. Description

- The M7108 is a balanced limiting low noise amplifier (LNA) fabricate on GaAs p-HEMT MMIC, integrated Lange Coupler, Limiter and LNA. It operates over 13-14GHz and achieves 1.7dB noise figure with 26dB gain.



M7108-PDS-F01

Figure 1. M7108 Functional Block Diagram

2. Applications

- TX/RX Modules
- Commercial and Military Radar
- Defense

3. Features

- Frequency Range: 13-14GHz
- Typical Gain: 26dB
- Noise Figure (NF): 1.7dB
- Input/Output Return Loss: -15dB
- Output P_{-1dB}: 13dBm
- Power Handling Capability: 46dBm
- Single Positive Supply: +5V (I_{DQ}=40mA)
- Dimensions: 2.8 x 2.4 x 0.1mm

4. Brief Typical Performance

Table 1. Brief Typical Performance

Parameter	13-14GHz	Units
Small-Signal Gain	26	dB
Noise Figure	1.7	dB
Input/Output Return Loss	-17	dB
Output P_{-1dB}	13	dBm
Power Handling Capability	46	dBm

- Test condition: Input signal pulsed, Pulse width = 50us, Duty cycle = 15%

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5. Recommended Operating Conditions

Table 2. Recommended Operating Conditions

Parameter	Min.	Typ.	Max.	Units
Operating Temperature Range	-55	25	125	°C
Supply Voltage, V_D	-	5	-	V
Quiescent Current, I_{DQ}	-	40	-	mA

6. RF Characteristics (T_C = 25˚C)

Table 3. RF Characteristics[1]

Parameter	Symbol	Min.	Typ.	Max.	Units
Small-Signal Gain	Gain	-	26	-	dB
Gain Flatness	ΔG	-	±0.3	-	dB
Noise Figure	NF	-	1.7	2	dB
Input Return Loss	RL_{IN}	-	-17	-	dB
Output Return Loss	RL_{OUT}	-	-17	-	dB
Output Power for 1dB Compression	OP_{-1dB}	-	13	-	dBm
Power Handling Capability	$P_{IN\ MAX}$	-	46	-	dBm

[1]. Test condition: Input signal pulsed, Pulse width = 50us, Duty cycle = 15%

7. Typical Performance Curve（T_C = 25°C）

■ Small-signal Characteristics Curve（V_D=5V, On-Wafer Test）

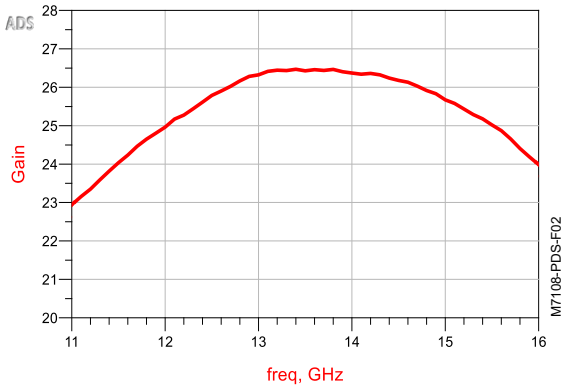


Figure 2. Small-signal Gain Characteristics

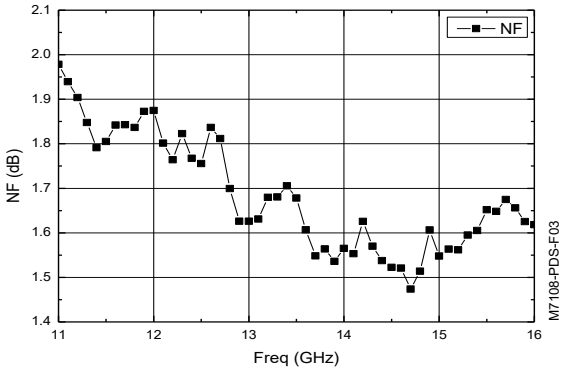


Figure 3. Noise Figure Characteristics

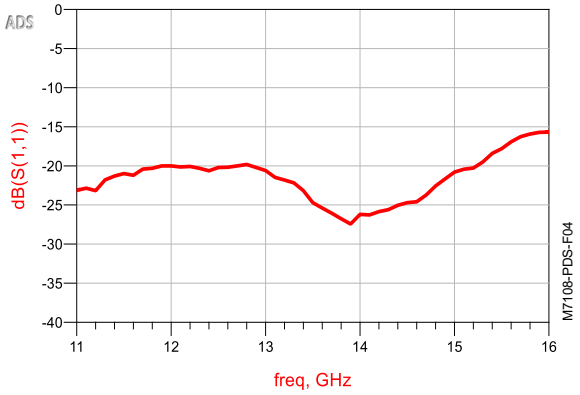


Figure 4. Input Return Loss Characteristics

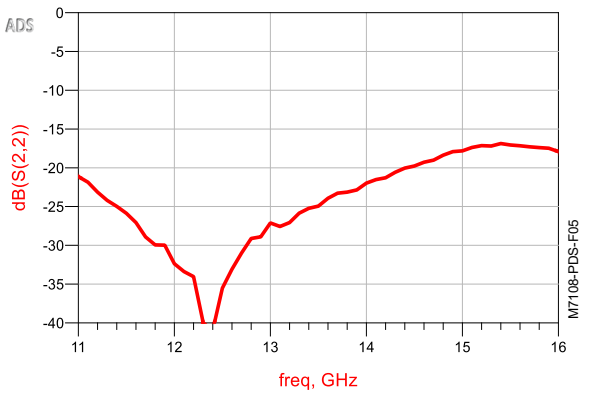


Figure 5. Output Return Loss Characteristics

■ Power Characteristic Curve（V_D=5V, On-Wafer Test）

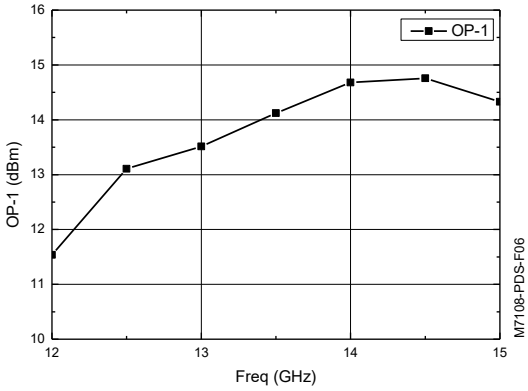
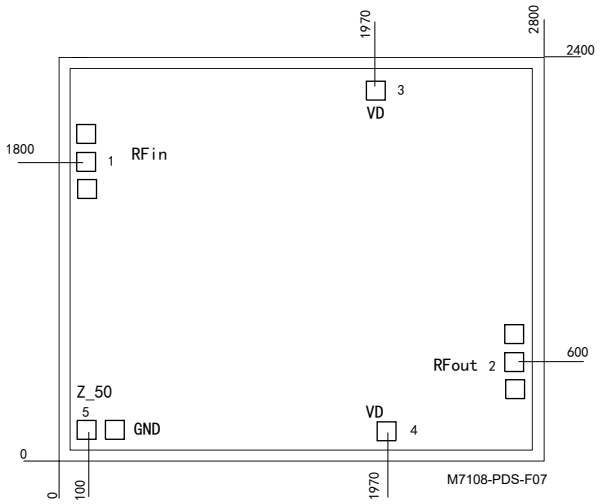


Figure 6. OP_{-1dB} Characteristics

8. Outline Dimensions



- Dimensions shown in micrometre

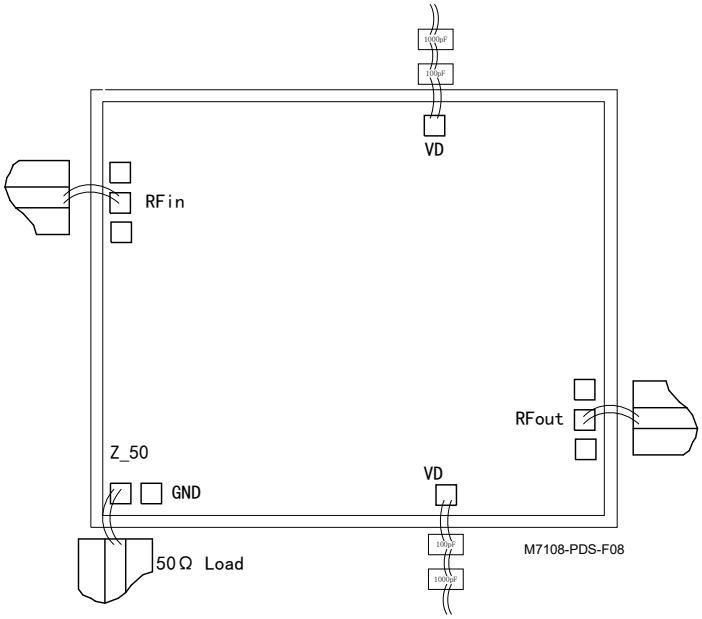
Figure 7. M7108 Outline Dimensions

Table 4. Pad Description

Pad	Symbol	Description
1	RF_{IN}	RF Input
2	RF_{OUT}	RF Output
3/4	VD	Supply Voltage (Arbitrary pad can be selected)
5	Load	50ohm Power Load

9. Assembly Information

■ Assembly Diagram



- For VD arbitrary pad can be selected

Figure 8. M7108 Assembly Diagram

- **Eutectic Die Attach:** It is best to use an 80% Au/20% Sn preform. Do not expose the chip to a temperature greater than 300°C for more than 30sec.
- **Wire Bonding:** RF bonds made with 1mil gold wire are recommended for the RF ports. Keep all bonds as short as possible, less than 0.35mm.

10. Handling Precautions

■ Storage

All bare dies ship in either Waffle or Gel Pak, which is an ESD protective container, and then sealed in an ESD protective bag. After opening the sealed ESD protective bag, all dies must be stored in a dry nitrogen environment.

■ Cleanliness

Handle the dies in a clean environment. Never use liquid cleaning systems to clean the dies.

■ ESD Caution

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore proper ESD precautions should be taken to avoid performance degradation or loss of functionality.



11. Contact Information

For the latest specifications, additional product information, technical support and sales support, please contact:

- **Email:** RF.support@raytrontek.com
- **Web:** www.raytrontek.com

12. Disclaimer

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